Q4 2018 Investor Conference

Charles Hsu Feb 15th, 2019



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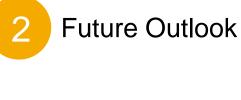
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Review of Operations

Q4 Financial Results

Revenue increased both quarter on quarter and year on year.

(thousands of NT dollars)

	Q4 2018 (Unaudited)	Q3 2018	Q4 2017	change (QoQ)	change (YoY)
Revenue	406,752	393,225	321,866	3.4%	26.4%
Gross Margin	100%	100%	100%	-	-
Operating Expenses	222,532	204,342	185,484	8.9%	20.0%
Operating Income	184,220	188,883	136,382	-2.5%	35.1%
Operating Margin	45.3%	48.0%	42.4%	-2.7ppts	2.9ppts
Net Income	163,611	168,572	117,659	-2.9%	39.1%
Net Margin	40.2%	42.9%	36.6%	-2.7ppts	3.6ppts
EPS (Unit: NTD)	2.20	2.23	1.55	-1.3%	41.9%
ROE	34.5%	34.8%	23.6%	-0.3ppts	10.9ppts

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FY2018 Financial Results

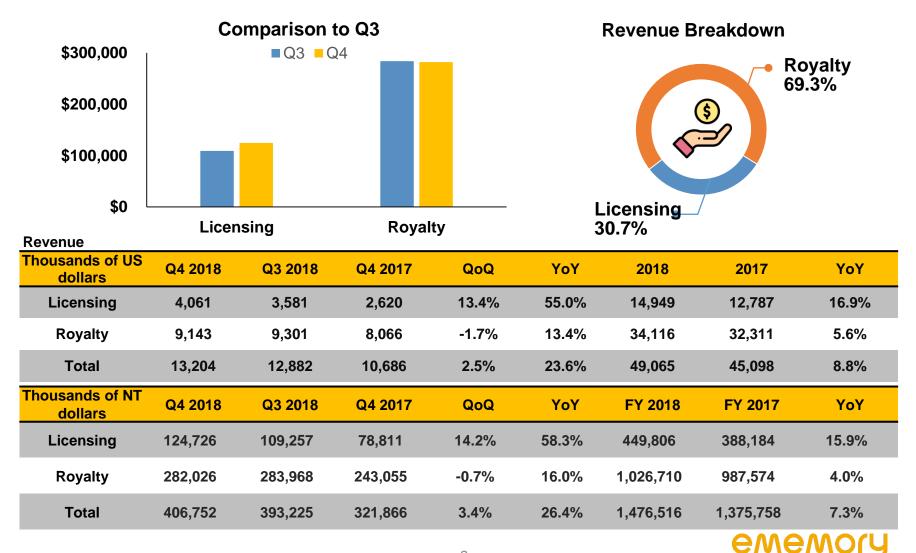
Revenue increased by 7.3%; EPS increased by 2.9%.

(thousands of NT dollars)

	FY 2018 (Unaudited)	FY 2017	change (YoY)
Revenue	1,476,516	1,375,758	7.3%
Gross Margin	100%	100%	-
Operating Expenses	803,781	772,940	4.0%
Operating Income	672,735	602,818	11.6%
Operating Margin	45.6%	43.8%	1.8ppts
Net Income	613,106	598,709	2.4%
Net Margin	41.5%	43.5%	-2.0ppts
EPS (Unit: NTD)	8.13	7.90	2.9%
ROE	32.3%	30.0%	2.3ppts eMeMO(y

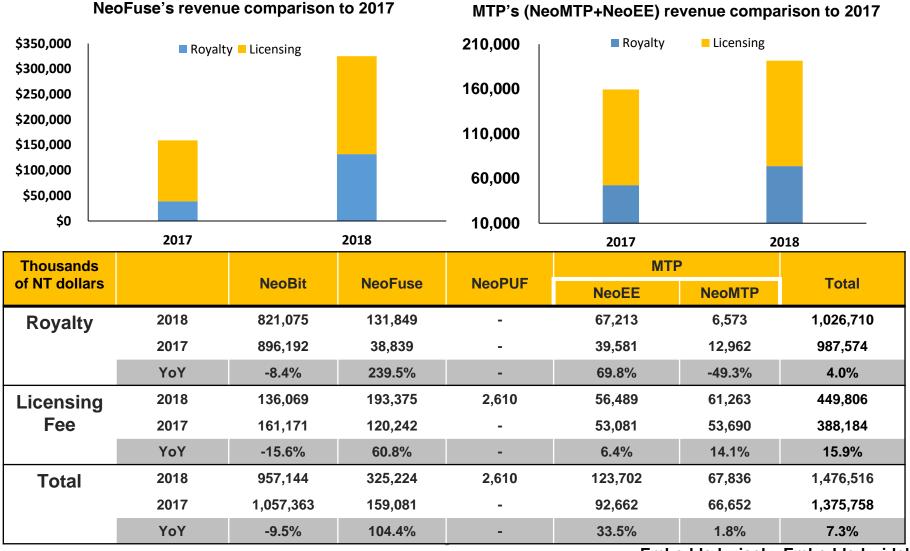
Q4 Revenue in Different Stream

FY 2018 licensing increased 15.9% while Royalty increased 4.0% over last year.



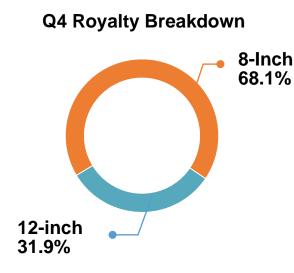
Previous efforts are cashing in

NeoFuse has 104.4% growth, and MTP has 20% growth.



Royalty Revenue by Wafer Size

Royalty from 12 inch increased due to new applications.



- ✓ In 2018, the royalty contribution from 12 inch wafers is about 32.6% of total, whereas it was 27.3% in 2017.
- ✓ 12 inch royalty revenue increased 24.3% in 2018 due to mass production of new applications. Q4 2018 declined 23.3% QoQ was due to two 12 inch foundries recognizing royalty in Q1 and Q3, but increased 67% YoY.
- ✓ 8 inch royalty declined 3.7% in 2018 due to wafer price erosion, customers' migration into 12 inch wafer, and new 8 inch customers' product not in mass production yet.

Royalty (thousands of NT dollars)

	Q4 2018			FY 2018	3
Wafer Size	% of Q4	Change (QoQ)	Change (YoY)	% of FY 2018	Change (YoY)
8-Inch	68.1%	15.2%	1.5%	67.4%	-3.7%
12-Inch	31.9%	-23.3%	67.0%	32.6%	24.3%

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Future Outlook

Growth Engine for 2019

Expect growth momentum continue to 2019 and beyond.





✓ Technology license:

1. More technologies to license, covering legacy to advance process nodes.

2. Expand our business into more foundries, IDMs and DRAM partners.

Design license:

- 1. Increasing IP number of our library
- 2. More applications drive more customers design cases.
- 3. Higher ASP of NeoFuse design license fee.



✓ 8 inch :

Mass production of leading US customers' PMIC related products and under-glass finger print sensors.

12 inch:

Mass production of new application, e.g. networks IC, DTV, STB, SSD controller, Bluetooth, OLED driver, TDDI, smart meter, surveillance and DRAM.



"Innovation distinguishes between a leader and a follower."

-Steve Jobs



Future Technology Development

- ✓ Continue developing 7nm & 5nm technology platform.
- ✓ Work with leading IDMs on emerging memory MRAM and ReRAM.
- Partnership with largest processor IP company to embed NeoFuse and NeoPUF as root of trust into secure processor.
- ✓ Establish NeoPUF based security IP.



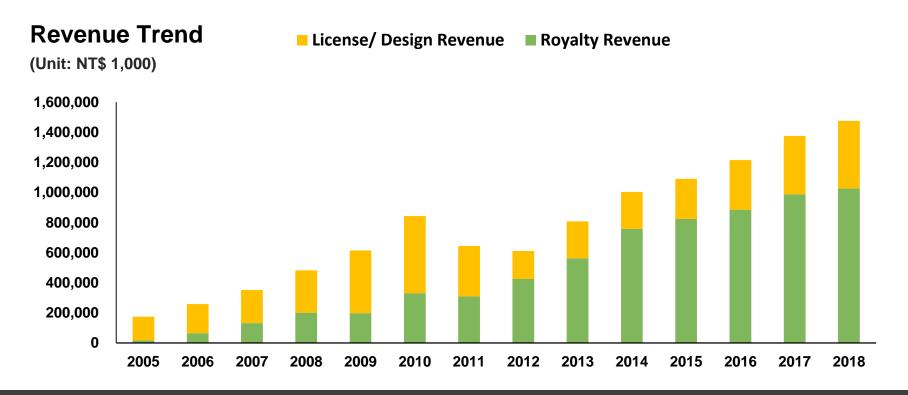




Appendix

Company Overview

eMemory is the global leader of embedded non-volatile memory IP



Founded

Based in Hsinchu, Taiwan. IPO in 2011

600+ Patents Issued

235 pending patents. 250 employees with 70% R&D personnel

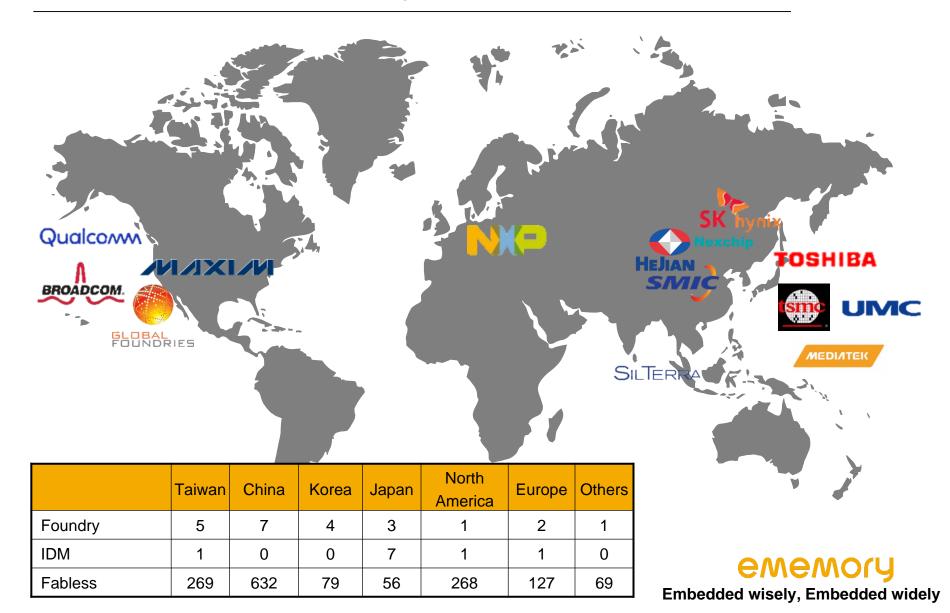
Best IP Partner

TSMC Best IP Partner Award since 2010.



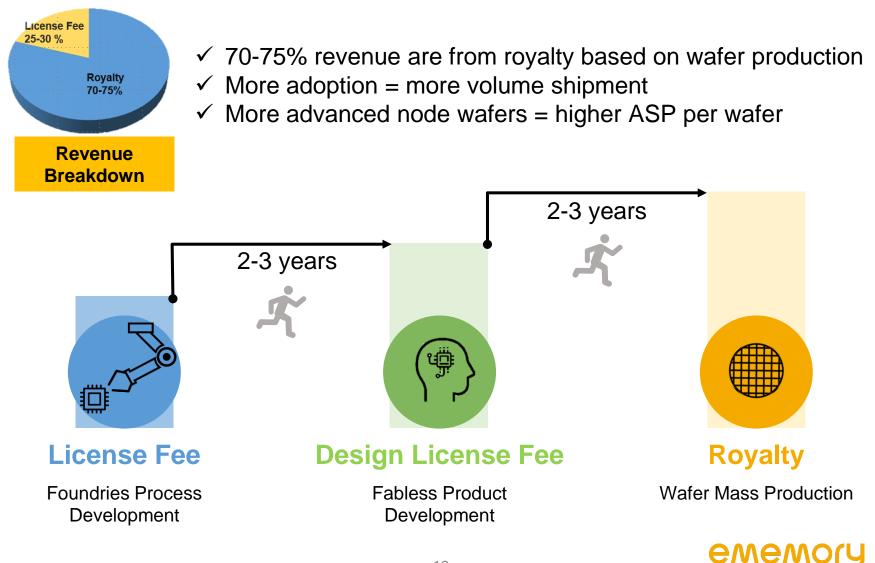
Worldwide Customers

Our IP solutions are adopted by leading foundries, IDMs and fabless worldwide



Business Model

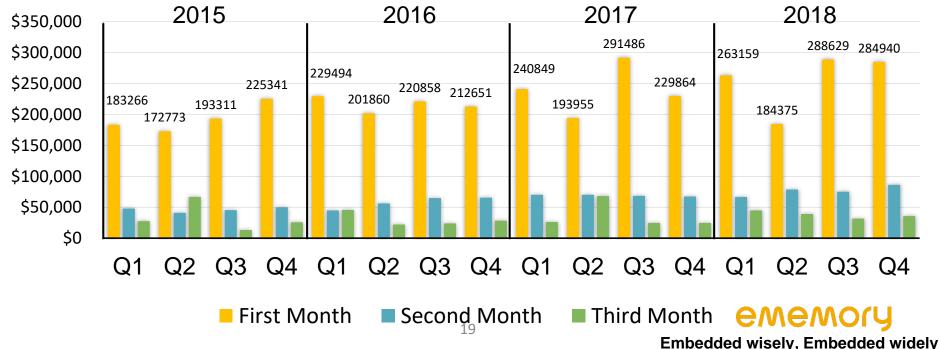
Recurring royalty is the backbone of our business



Quarterly Revenue Pattern

eMemory's revenue are mostly received in the first month of the quarter

- ✓ 1st month: Receive License Fees of the month and Royalty from most foundries on previous quarter's wafer shipments
- ✓ 2nd month: Receive License Fees of the month and Royalty from other foundries
- ✓ 3rd month: License Fees Only.
- ✓ Two foundries pay royalty semiannually, reported in Jan and July Revenue.



Thousands of NT dollars

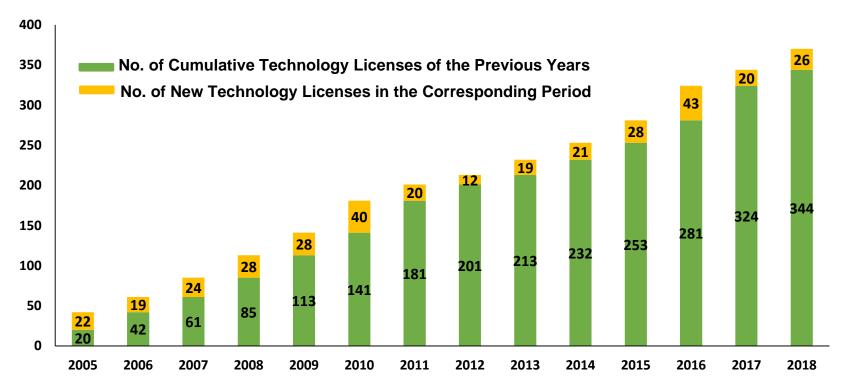
Technology Licenses

Cumulative technology licenses

Number of Licenses

Year	2015	2016	2017	2018
License	28	43	20	26

Note: Terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.



Embedded wisely, Embedded widely

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New Technology under Development

Products in different process nodes

- New technologies being developed for 92 platforms by Q4 2018.
- 7 licensing contracts were signed, 2 for NeoBit, 3 for NeoFuse, 1 for NeoEE, and 1 for NeoMTP.

	7/10nm	12/14/16nm	22/28nm	40nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um
NeoBit	-	-	-	-	1	1	9	7
NeoFuse	2	2	12	6	7	9	3	2
NeoPUF	-	-	2	2	2	-	-	-
NeoEE	-	-	-	-	-	1	3	5
NeoMTP	-	-	-	-	2	-	5	9

As of Dec 31st, 2018

Technology Development

Developments by process node

12" Fabs	Production	Development	ІР Туре	Process Type
7/10nm	0	2	ОТР	FF, FF+
12/14/16nm	3	2	ОТР	FF, FF+
22/28nm	15	14	NeoPUF, OTP	ULP/HPM, HPC/HPC+, HV-OLED, DRAM, SOI
40nm	10	8	NeoPUF, OTP, MTP	LP/ULP, HV-DDI/OLED, eFlash
55/65nm	19	12	NeoPUF, OTP, MTP	LP/ULP, HV-DDI/OLED, CIS, eFlash, DRAM, BCD, PM
80/90nm	10	6	ОТР, МТР	HV-DDI/OLED, LP, eFlash, Generic
0.13/0.11um	12	6	OTP, MTP	HV-DDI, BCD, Generic
0.18um	1	0	ОТР	BCD
Total		50		

8" Fabs	Development	ІР Туре	Process Type
90nm	5	ΟΤΡ	HV-DDI, LL, BCD
0.13/0.11um	14	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Flash, SOI
0.18/0.16/0.152um	23	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Generic
0.25um	0	OTP, MTP	BCD
0.35um	0	ОТР	UHV
Total	42		

Note: As of Dec. 31st, 2018

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